

BALANCED

RF Transformer

TRS1-182-75-4+

Mini-Circuits

75Ω 10 to 1800 MHz 1:1 Ratio

FEATURES

- Suitable for Tin/Lead and RoHS Solder Systems
- Wideband, 10 to 1800 MHz
- Balanced Transmission Line
- Good Return Loss, 20 dB Typ. at 1 dB Band
- Excellent Amplitude Unbalance, 0.3 dB Typ.
- Aqueous Washable
- Excellent Intermod Suppression



Generic photo used for illustration purposes only

CASE STYLE: TT1618-1

+RoHS Compliant

The +Suffix identifies RoHS Compliance.
See our website for methodologies and qualifications

ELECTRICAL SPECIFICATIONS AT +25°C

Parameter	Frequency (MHz)	Min.	Typ.	Max.	Unit
Impedance Ratio			1		
Frequency Range		10		1800	MHz
Insertion Loss ¹	50-1200		0.6	1.0	dB
	10-1800		0.9	2.0	
Amplitude Unbalance	50-1000		0.3	0.7	dB
	1000-1200		0.5	0.7	
	10-1800		0.7	1.4	
Phase Unbalance	50-1000		2	4	Degree
	1000-1200		3	8	
	10-1800		7.5	15	
Primary Return Loss (Input)	50-500	16	22		dB
	500-1000	13	20		
	1000-1200	13	20		
	10-1800	8	12.5		

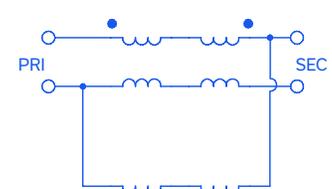
1. Insertion Loss is referenced to mid-band loss, 0.25 dB typ.

ABSOLUTE MAXIMUM RATINGS

Parameter	Ratings
Operating Temperature	-40°C to +85°C
Storage Temperature	-55°C to +100°C
RF Power	1 W
DC Current	30 mA

Permanent damage may occur if any of these limits are exceeded.

CONFIG. K



REV. B
ECO-028366
TRS1-182-75-4+
MCL NY
260128





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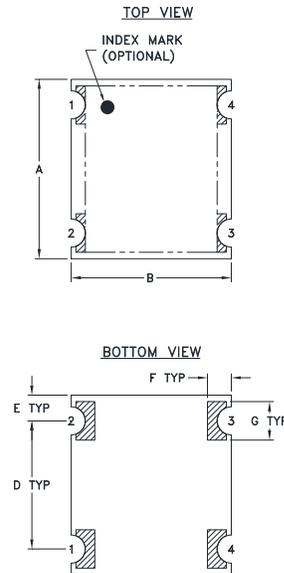
PIN CONNECTIONS

PRIMARY DOT	4
PRIMARY	1
SECONDARY DOT	2
SECONDARY	3

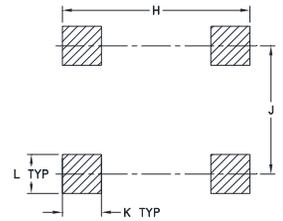
PRODUCT MARKING: N/A

DEMO BOARD MCL P/N: TB-TRS1-182-75+

OUTLINE DRAWING



PCB Land Pattern



SUGGESTED LAYOUT
TOLERANCE TO BE WITHIN ±.002

OUTLINE DIMENSIONS (Inch/mm)

A	B	C	D	E	F
.280	.250	.16	.200	.040	.037
7.11	6.35	4.06	5.08	1.02	0.94
G	H	J	K	L	wt.
.060	.293	.200	.061	.061	grams
1.52	7.44	5.08	1.55	1.55	3.00

TAPE & REEL INFORMATION: F34





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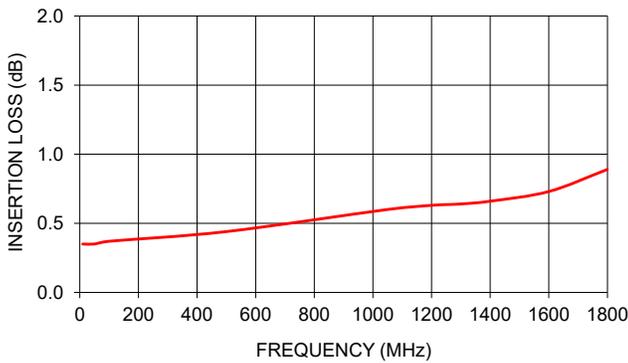
Mini-Circuits

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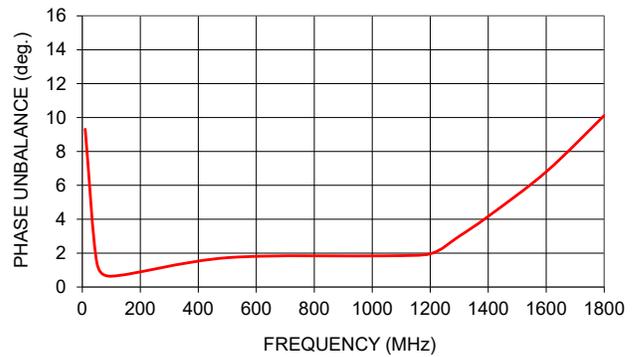
TYPICAL PERFORMANCE DATA

FREQUENCY (MHz)	INSERTION LOSS (dB)	INPUT R. LOSS (dB)	AMPLITUDE UNBALANCE (dB)	PHASE UNBALANCE (Deg.)
10	0.35	11.81	0.40	9.31
50	0.35	24.24	0.23	1.45
100	0.37	24.82	0.21	0.64
500	0.44	19.21	0.00	1.73
1050	0.60	18.90	0.22	1.84
1200	0.63	20.28	0.23	1.96
1300	0.64	21.30	0.25	3.00
1400	0.66	22.02	0.28	4.17
1600	0.73	21.17	0.31	6.80
1800	0.89	14.58	0.35	10.12

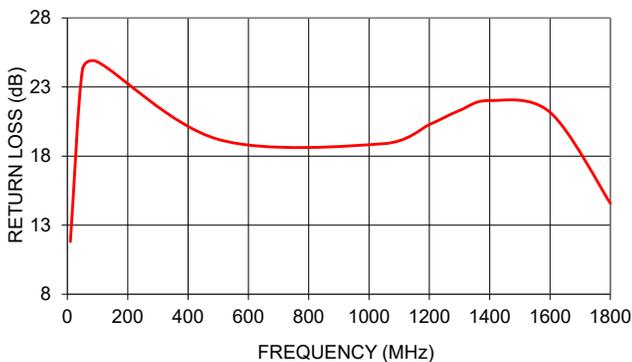
INSERTION LOSS



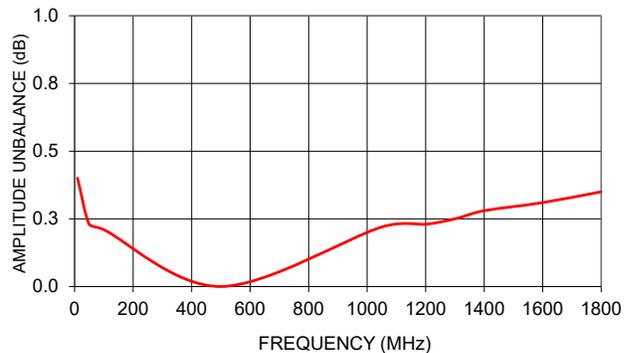
PHASE UNBALANCE



INPUT RETURN LOSS



AMPLITUDE UNBALANCE



NOTES

- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
- C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard. Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/terms/viewterm.html



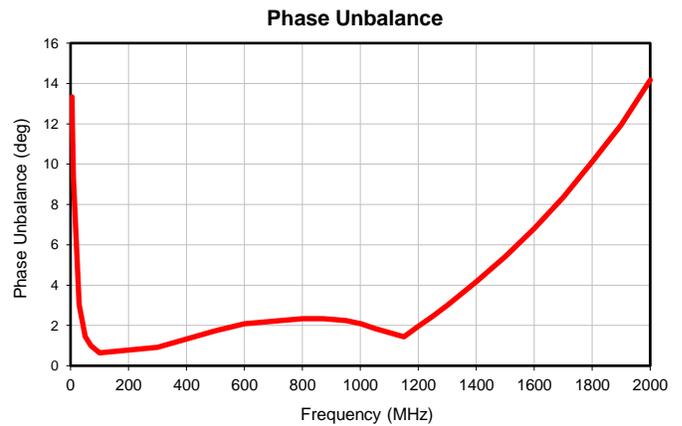
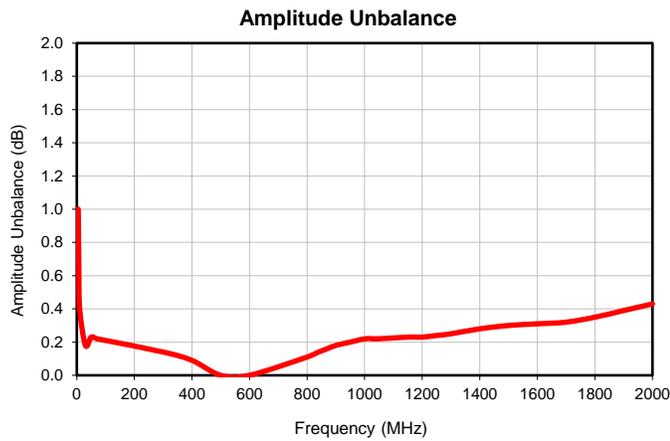
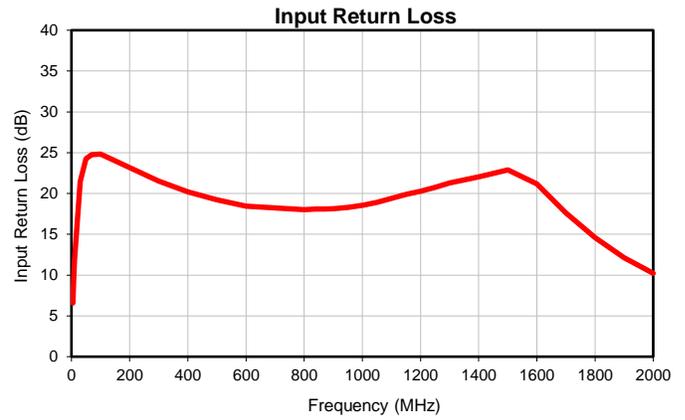
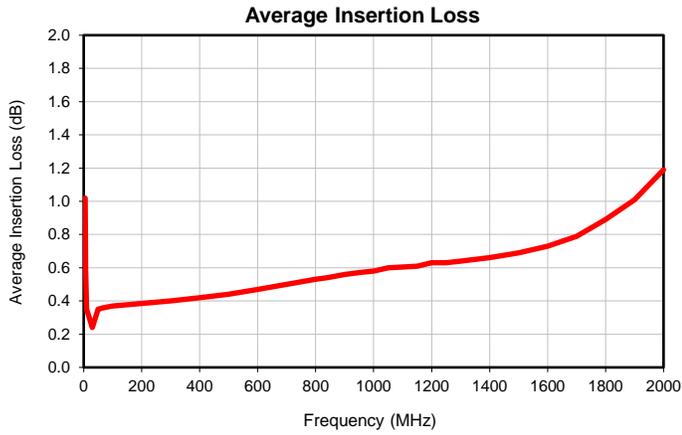
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Typical Performance Data

FREQUENCY MHz	AVERAGE INSERTION LOSS (dB)	INPUT RETURN LOSS (dB)	AMPLITUDE UNBALANCE (dB)	PHASE UNBALANCE (deg.)
5	1.02	6.57	1.00	13.33
7	0.59	8.98	0.66	11.72
10	0.35	11.81	0.40	9.31
30	0.24	21.48	0.18	3.03
50	0.35	24.24	0.23	1.45
70	0.36	24.77	0.22	0.99
100	0.37	24.82	0.21	0.64
300	0.40	21.53	0.14	0.91
400	0.42	20.19	0.09	1.33
500	0.44	19.21	0.00	1.73
600	0.47	18.45	0.00	2.09
800	0.53	18.01	0.11	2.33
840	0.54	18.08	0.14	2.34
870	0.55	18.08	0.16	2.34
900	0.56	18.13	0.18	2.31
950	0.57	18.28	0.20	2.24
1002	0.58	18.57	0.22	2.08
1050	0.60	18.90	0.22	1.84
1150	0.61	19.87	0.23	1.44
1200	0.63	20.28	0.23	1.96
1250	0.63	20.73	0.24	2.46
1300	0.64	21.30	0.25	3.00
1400	0.66	22.02	0.28	4.17
1500	0.69	22.90	0.30	5.41
1600	0.73	21.17	0.31	6.80
1700	0.79	17.62	0.32	8.34
1800	0.89	14.58	0.35	10.12
1900	1.01	12.12	0.39	11.95
2000	1.19	10.23	0.43	14.17

Typical Performance Data

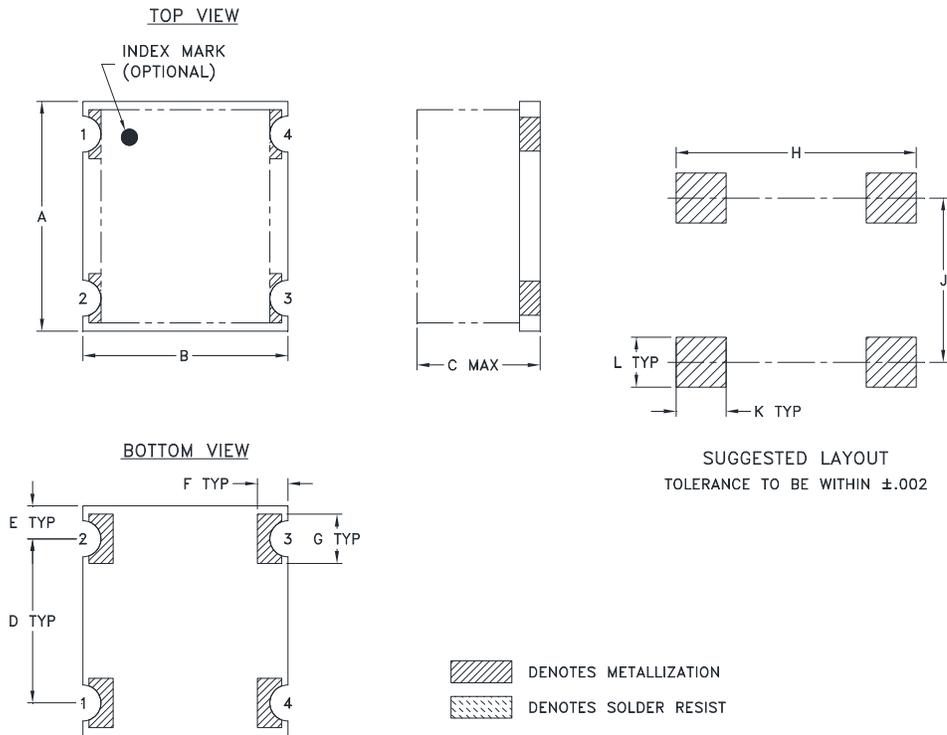


Case Style

TT1618-1

Outline Dimensions

PCB Land Pattern



CASE #	A	B	C	D	E	F	G	H	J	K	L	WT GRAMS
TT1618-1	.280 (7.11)	.250 (6.35)	.16 (4.06)	.200 (5.08)	.040 (1.02)	.037 (.94)	.060 (1.52)	.293 (7.44)	.200 (5.08)	.061 (1.55)	.061 (1.55)	3.00

Dimensions are in inches (mm). Tolerances: 2Pl. $\pm .01$; 3 Pl. $\pm .005$

Notes:

1. Open style, Base material: Printed wiring laminate.
2. Termination finish: 3-5 μ inch (.08-.13 microns) Gold over 120-240 μ inch (3.05-6.10 microns) Nickel plate.
All models, (+) suffix.



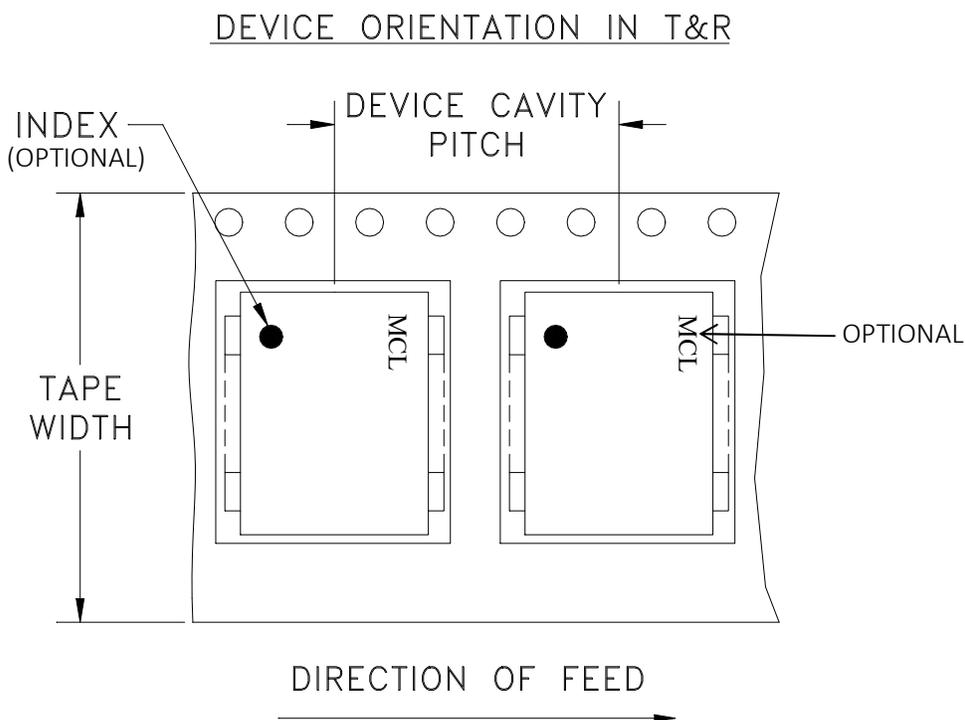
P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site



The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com

RF/IF MICROWAVE COMPONENTS

Tape & Reel Packaging TR-F34



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel see note	
16	12	7	Small quantity standard (see note)	20
				50
				100
				200
		13	Standard	500
				1000

Note: Availability of small reel quantity varies by model.
Refer to pricing and availability on individual model dashboard.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf



INTERNET <http://www.minicircuits.com>

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Mini-Circuits ISO 9001 & ISO 14001 Certified

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-40° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215